



5. The polyamide resin composition according to claim 1 further comprising (E) 0.05 to 5 parts by weight of a phenolic antioxidant based on 100 parts by weight of the polyamide resins (A) and (B).

6. The polyamide resin composition according to claim 1 further comprising (F) 0.01 to 5 parts by weight of a copper compound, a halide or mixture thereof based on 100 parts by weight of the polyamide resins (A) and (B).

7. The polyamide resin composition according to claim 1, wherein relative viscosity of (A) the polyamide 6 resin, polyamide 66 resin or mixture thereof is 1.8 to 3.5.

8. The polyamide resin composition according to claim 1, wherein the diamine units comprises 20 to 45 mol% of paraxylylenediamine units and 55 to 80 mol% of methaxylylenediamine units.

9. The polyamide resin composition according to claim 1, wherein the aliphatic dicarboxylic acid is an α,ω -straight-chain aliphatic dicarboxylic acid.

10. The polyamide resin composition according to claim 1, wherein the aliphatic dicarboxylic acid is an aliphatic dicarboxylic acid having 6 to 12 carbon atoms.